

MOS FIELD EFFECT TRANSISTOR μ PA2707TP

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The μ PA2707TP which has a heat spreader is N-channel MOS Field Effect Transistor designed for DC/DC converter and power management applications of notebook computer.

FEATURES

• Low on-state resistance

 $R_{DS(on)1}$ = 4.3 m Ω MAX. (Vgs = 10 V, ID = 9.0 A)

 $R_{DS(on)2}$ = 5.6 m Ω MAX. (Vgs = 4.5 V, ID = 9.0 A)

- Low Ciss: Ciss = 6600 pF TYP. (VDS = 10 V, VGS = 0 V)
- Small and surface mount package (Power HSOP8)

ORDERING INFORMATION

PART NUMBER	PACKAGE		
μ PA2707TP-E1	Power HSOP8		
μ PA2707TP-E1-AZ Note	Power HSOP8		
μ PA2707TP-E2	Power HSOP8		
μ PA2707TP-E2-AZ Note	Power HSOP8		

Note Pb-free (This product does not contain Pb in external electrode.)

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	30	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC)	I _{D(DC)}	±42	Α
Drain Current (pulse) Note1	I _{D(pulse)}	±76	Α
Total Power Dissipation (Tc = 25°C)	P _{T1}	40	W
Total Power Dissipation Note2	P _{T2}	4.3	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C
Single Avalanche Current Note3	las	19	Α
Single Avalanche Energy Note3	Eas	36	mJ

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

- 2. Mounted on glass epoxy board of 1 inch x 1 inch x 0.8 mm, PW =10 sec
- 3. Starting T_{ch} = 25°C, V_{DD} = 15 V, R_G = 25 Ω , L = 100 μ H, V_{GS} = 20 \rightarrow 0 V

THERMAL RESISTANCE

Channel to Ambient Note	Rth(ch-A)	96.2	°C/W
Channel to Case	Rth(ch-C)	3.13	°C/W

Note Mounted on glass epoxy board of 1 inch x 1 inch x 0.8 mm

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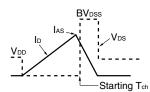
ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V _{DS} = 30 V, V _{GS} = 0 V			10	μΑ
Gate Leakage Current	Igss	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.0		2.5	V
Forward Transfer Admittance Note	y fs	V _{DS} = 10 V, I _D = 10 A	12			S
Drain to Source On-state Resistance Note	R _{DS(on)1}	V _{GS} = 10 V, I _D = 10 A		3.3	4.3	mΩ
	RDS(on)2	V _{GS} = 4.5 V, I _D = 10 A		4.1	5.6	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		6600		pF
Output Capacitance	Coss	V _{GS} = 0 V		970		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		530		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 15 V, I _D = 10 A		24		ns
Rise Time	tr	V _{GS} = 10 V		29		ns
Turn-off Delay Time	t _{d(off)}	R _G = 10 Ω		130		ns
Fall Time	t _f			39		ns
Total Gate Charge	QG	V _{DD} = 15 V		52		nC
Gate to Source Charge	Qgs	V _{GS} = 5 V		16		nC
Gate to Drain Charge	Q _{GD}	I _D = 19 A		18		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = 19 A, V _{GS} = 0 V		0.8		V
Reverse Recovery Time	trr	I _F = 19 A, V _{GS} = 0 V		42		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		41		nC
Gate Resistance	Rg	f = 1 MHz		1.2		Ω

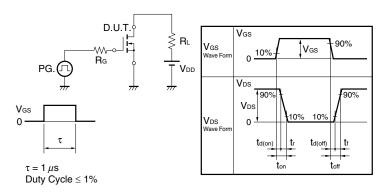
Note Pulsed

TEST CIRCUIT 1 AVALANCHE CAPABILITY

$\begin{array}{c} \text{D.U.T.} \\ \text{RG} = 25 \ \Omega \\ \text{VGS} = 20 \rightarrow 0 \ \text{V} \end{array} \begin{array}{c} \text{D.U.T.} \\ \text{RG} = 25 \ \Omega \\ \text{W} \end{array} \begin{array}{c} \text{D.U.T.} \\ \text{VDD} \end{array}$



TEST CIRCUIT 2 SWITCHING TIME

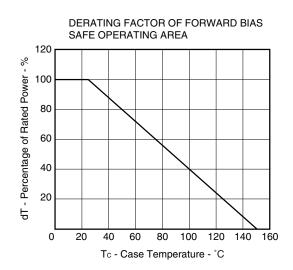


TEST CIRCUIT 3 GATE CHARGE

$$\begin{array}{c|c} D.U.T. \\ \hline I_G = 2 \text{ mA} \\ \hline \end{array}$$

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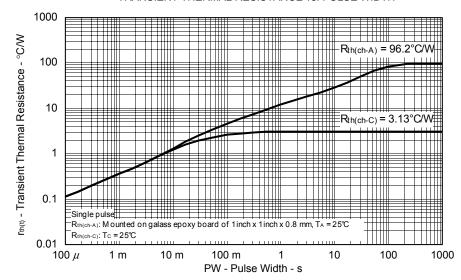
TYPICAL CHARACTERISTICS (TA = 25°C)



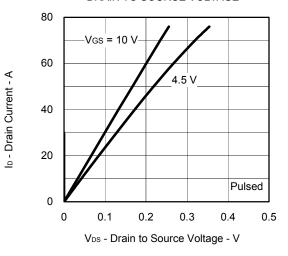
TC = 25°C Single pulse 0.01 100 | Diplose |

V_{DS} - Drain to Source Voltage - V

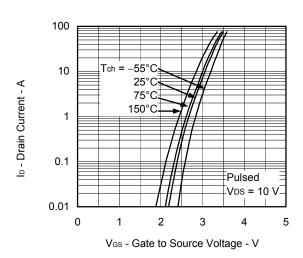
TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH





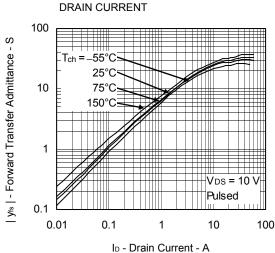


FORWARD TRANSFER CHARACTERISTICS



GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE 3 Ves(off) - Gate Cut-off Voltage - V 2 1 Vps = 10 V Pulsed 0 -50 0 50 100 150

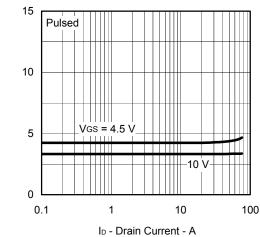




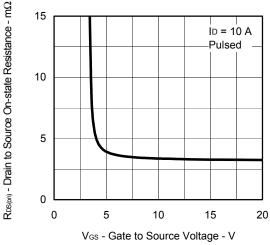
FORWARD TRANSFER ADMITTANCE vs.

DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT R_{DS(m)} - Drain to Source On-state Resistance - mΩ 15 Pulsed

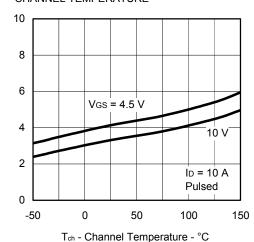
Tch - Channel Temperature - °C



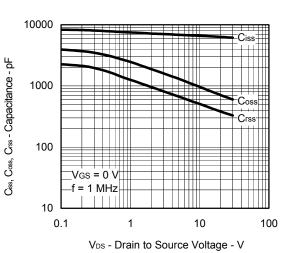
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. **CHANNEL TEMPERATURE**



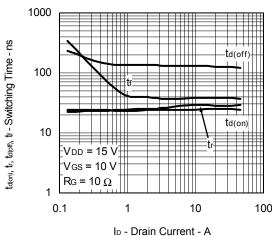
CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



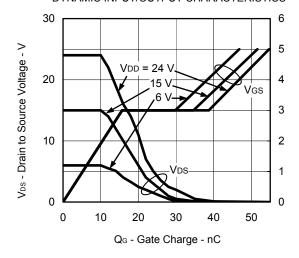
RDS(01) - Drain to Source On-state Resistance - m\Omega

Ves - Gate to Source Voltage - V

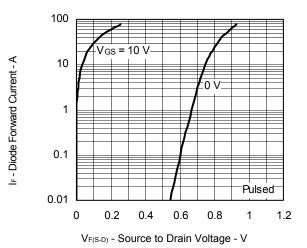
SWITCHING CHARACTERISTICS



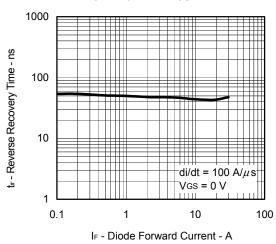
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



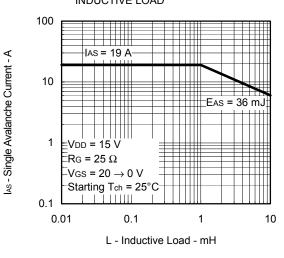
SOURCE TO DRAIN DIODE FORWARD VOLTAGE



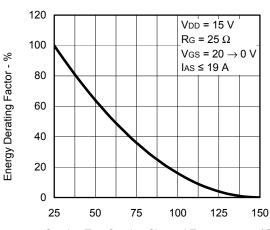
REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT



SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD



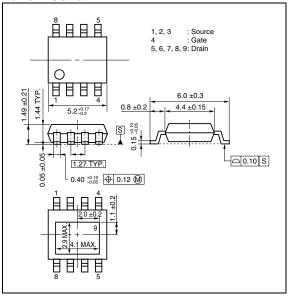
SINGLE AVALANCHE ENERGY DERATING FACTOR



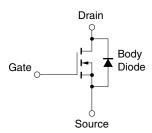
Starting Tch - Starting Channel Temperature - °C

PACKAGE DRAWING (Unit: mm)

Power HSOP8



EQUIVALENT CIRCUIT



Remark Strong electric field, when exposed to this device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it once, when it has occurred.

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